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# 74HC21

## Dual 4-input AND gate

Rev. 03 — 12 November 2004

Product data sheet

### 1. General description

The 74HC21 is a high-speed Si-gate CMOS device and is pin compatible with low-power Schottky TTL (LSTTL). The 74HC21 is specified in compliance with JEDEC standard no. 7A.

The 74HC21 provide the 4-input AND function.

### 2. Features

- Low-power dissipation
- Complies with JEDEC standard no. 7A
- ESD protection:
  - ◆ HBM EIA/JESD22-A114-B exceeds 2000 V
  - ◆ MM EIA/JESD22-A115-A exceeds 200 V.
- Multiple package options
- Specified from -40 °C to +80 °C and from -40 °C to +125 °C.

### 3. Quick reference data

**Table 1: Quick reference data**

$GND = 0 \text{ V}$ ;  $T_{amb} = 25 \text{ }^{\circ}\text{C}$ ;  $t_r = t_f = 6 \text{ ns}$ .

Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
$t_{PHL}, t_{PLH}$	propagation delay nA, nB, nC, nD to nY	$C_L = 15 \text{ pF};$ $V_{CC} = 5 \text{ V}$	-	10	-	ns	
$C_I$	input capacitance		-	3.5	-	pF	
$C_{PD}$	power dissipation capacitance	$V_I = GND \text{ to } V_{CC}$	[1]	-	15	-	pF

[1]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu\text{W}$ ).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

$f_i$  = input frequency in MHz;

$f_o$  = output frequency in MHz;

$C_L$  = output load capacitance in pF;

$V_{CC}$  = supply voltage in V;

N = number of inputs switching;

$\sum(C_L \times V_{CC}^2 \times f_o)$  = sum of outputs.

**PHILIPS**

## 4. Ordering information

**Table 2: Ordering information**

Type number	Package	Temperature range	Name	Description	Version
74HC21N		-40 °C to +125 °C	DIP14	plastic dual in-line package; 14 leads (300 mil)	SOT27-1
74HC21D		-40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1
74HC21DB		-40 °C to +125 °C	SSOP14	plastic shrink small outline package; 14 leads; body width 5.3 mm	SOT337-1

## 5. Functional diagram

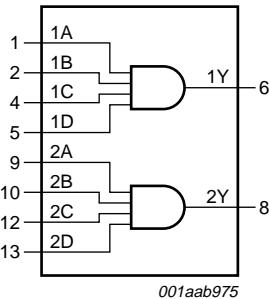


Fig 1. Functional diagram

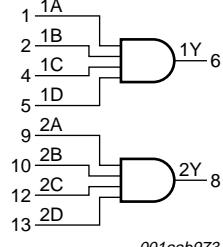


Fig 2. Logic symbol

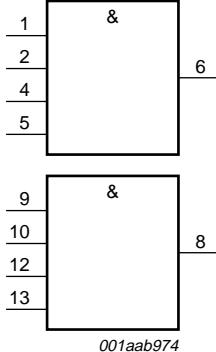


Fig 3. IEC logic symbol

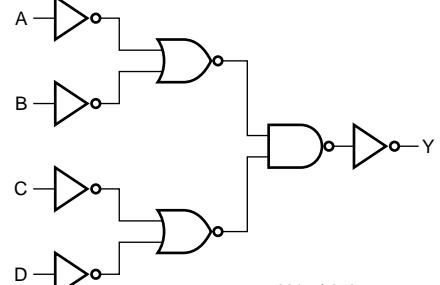


Fig 4. Logic diagram

## 6. Pinning information

### 6.1 Pinning

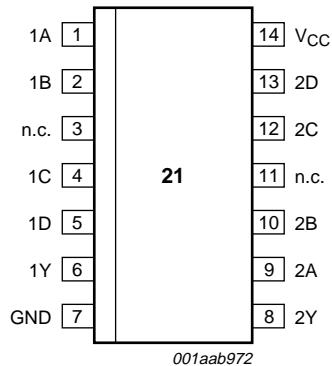


Fig 5. Pin configuration

### 6.2 Pin description

Table 3: Pin description

Symbol	Pin	Description
1A	1	data input 1A
1B	2	data input 1B
n.c.	3	not connected
1C	4	data input 1C
1D	5	data input 1D
1Y	6	data output 1
GND	7	ground (0 V)
2Y	8	data output 2
2A	9	data input 2A
2B	10	data input 2B
n.c.	11	not connected
2C	12	data input 2C
2D	13	data input 2D
V <sub>CC</sub>	14	positive supply voltage

## 7. Functional description

### 7.1 Function table

**Table 4: Function table [1]**

Input				Output
nA	nB	nC	nD	nY
L	X	X	X	L
X	L	X	X	L
X	X	L	X	L
X	X	X	L	L
H	H	H	H	H

[1] H = HIGH voltage level;  
L = LOW voltage level;  
X = don't care.

## 8. Limiting values

**Table 5: Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+7	V
$I_{IK}$	input diode current	$V_I < -0.5 \text{ V}$ or $V_I > V_{CC} + 0.5 \text{ V}$	-	$\pm 20$	mA
$I_{OK}$	output diode current	$V_O < -0.5 \text{ V}$ or $V_O > V_{CC} + 0.5 \text{ V}$	-	$\pm 20$	mA
$I_O$	output source or sink current	$V_O = -0.5 \text{ V}$ to $V_{CC} + 0.5 \text{ V}$	-	$\pm 25$	mA
$I_{CC}, I_{GND}$	$V_{CC}$ or GND current		-	$\pm 50$	mA
$T_{stg}$	storage temperature		-65	+150	°C
$P_{tot}$	power dissipation				
	DIP14 package		[1]	-	mW
	SO14 and SSOP14 packages		[2]	-	500 mW

[1] Above 70 °C:  $P_{tot}$  derates linearly with 12 mW/K.

[2] Above 70 °C:  $P_{tot}$  derates linearly with 8 mW/K.

## 9. Recommended operating conditions

**Table 6: Recommended operating conditions**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{CC}$	supply voltage		2.0	5.0	6.0	V
$V_I$	input voltage		0	-	$V_{CC}$	V
$V_O$	output voltage		0	-	$V_{CC}$	V
$t_r, t_f$	input rise and fall times	$V_{CC} = 2.0$ V	-	-	1000	ns
		$V_{CC} = 4.5$ V	-	6.0	500	ns
		$V_{CC} = 6.0$ V	-	-	400	ns
$T_{amb}$	ambient temperature		-40	-	+125	°C

## 10. Static characteristics

**Table 7: Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b><math>T_{amb} = 25</math> °C</b>						
$V_{IH}$	HIGH-level input voltage	$V_{CC} = 2.0$ V	1.5	1.2	-	V
		$V_{CC} = 4.5$ V	3.15	2.4	-	V
		$V_{CC} = 6.0$ V	4.2	3.2	-	V
$V_{IL}$	LOW-level input voltage	$V_{CC} = 2.0$ V	-	0.8	0.5	V
		$V_{CC} = 4.5$ V	-	2.1	1.35	V
		$V_{CC} = 6.0$ V	-	2.8	1.8	V
$V_{OH}$	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_O = -20 \mu A; V_{CC} = 2.0$ V	1.9	2.0	-	V
		$I_O = -20 \mu A; V_{CC} = 4.5$ V	4.4	4.5	-	V
		$I_O = -20 \mu A; V_{CC} = 6.0$ V	5.9	6.0	-	V
		$I_O = -4 mA; V_{CC} = 4.5$ V	3.98	4.32	-	V
$V_{OL}$	LOW-level output voltage	$I_O = -5.2 mA; V_{CC} = 6.0$ V	5.48	5.81	-	V
		$V_I = V_{IH}$ or $V_{IL}$				
		$I_O = 20 \mu A; V_{CC} = 2.0$ V	-	0	0.1	V
		$I_O = 20 \mu A; V_{CC} = 4.5$ V	-	0	0.1	V
		$I_O = 20 \mu A; V_{CC} = 6.0$ V	-	0	0.1	V
		$I_O = 4 mA; V_{CC} = 4.5$ V	-	0.15	0.26	V
$I_{LI}$	input leakage current	$I_O = 5.2 mA; V_{CC} = 6.0$ V	-	0.16	0.26	V
		$V_I = V_{CC}$ or GND; $V_{CC} = 6.0$ V	-	-	$\pm 0.1$	$\mu A$
$I_{CC}$	quiescent supply current	$V_I = V_{CC}$ or GND; $I_O = 0 A; V_{CC} = 6.0$ V	-	-	2.0	$\mu A$
$C_I$	input capacitance		-	3.5	-	pF

**Table 7: Static characteristics ...continued**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>T<sub>amb</sub> = -40 °C to +85 °C</b>						
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 2.0 V	1.5	-	-	V
		V <sub>CC</sub> = 4.5 V	3.15	-	-	V
		V <sub>CC</sub> = 6.0 V	4.2	-	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 2.0 V	-	-	0.5	V
		V <sub>CC</sub> = 4.5 V	-	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	-	1.8	V
V <sub>OH</sub>	HIGH-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		I <sub>O</sub> = -20 µA; V <sub>CC</sub> = 2.0 V	1.9	-	-	V
		I <sub>O</sub> = -20 µA; V <sub>CC</sub> = 4.5 V	4.4	-	-	V
		I <sub>O</sub> = -20 µA; V <sub>CC</sub> = 6.0 V	5.9	-	-	V
		I <sub>O</sub> = -4 mA; V <sub>CC</sub> = 4.5 V	3.84	-	-	V
V <sub>OL</sub>	LOW-level output voltage	I <sub>O</sub> = -5.2 mA; V <sub>CC</sub> = 6.0 V	5.34	-	-	V
		V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		I <sub>O</sub> = 20 µA; V <sub>CC</sub> = 2.0 V	-	-	0.1	V
		I <sub>O</sub> = 20 µA; V <sub>CC</sub> = 4.5 V	-	-	0.1	V
		I <sub>O</sub> = 20 µA; V <sub>CC</sub> = 6.0 V	-	-	0.1	V
I <sub>LI</sub>	input leakage current	I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 4.5 V	-	-	0.33	V
		I <sub>O</sub> = 5.2 mA; V <sub>CC</sub> = 6.0 V	-	-	0.33	V
I <sub>CC</sub>	quiescent supply current	V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 6.0 V	-	-	20.0	µA

**Table 7: Static characteristics ...continued**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>T<sub>amb</sub> = -40 °C to +125 °C</b>						
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 2.0 V	1.5	-	-	V
		V <sub>CC</sub> = 4.5 V	3.15	-	-	V
		V <sub>CC</sub> = 6.0 V	4.2	-	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 2.0 V	-	-	0.5	V
		V <sub>CC</sub> = 4.5 V	-	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	-	1.8	V
V <sub>OH</sub>	HIGH-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		I <sub>O</sub> = -20 µA; V <sub>CC</sub> = 2.0 V	1.9	-	-	V
		I <sub>O</sub> = -20 µA; V <sub>CC</sub> = 4.5 V	4.4	-	-	V
		I <sub>O</sub> = -20 µA; V <sub>CC</sub> = 6.0 V	5.9	-	-	V
		I <sub>O</sub> = -4 mA; V <sub>CC</sub> = 4.5 V	3.7	-	-	V
V <sub>OL</sub>	LOW-level output voltage	I <sub>O</sub> = -5.2 mA; V <sub>CC</sub> = 6.0 V	5.2	-	-	V
		V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		I <sub>O</sub> = 20 µA; V <sub>CC</sub> = 2.0 V	-	-	0.1	V
		I <sub>O</sub> = 20 µA; V <sub>CC</sub> = 4.5 V	-	-	0.1	V
		I <sub>O</sub> = 20 µA; V <sub>CC</sub> = 6.0 V	-	-	0.1	V
I <sub>LI</sub>	input leakage current	I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 4.5 V	-	-	0.4	V
		I <sub>O</sub> = 5.2 mA; V <sub>CC</sub> = 6.0 V	-	-	0.4	V
I <sub>cc</sub>	quiescent supply current	V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 6.0 V	-	-	40.0	µA

## 11. Dynamic characteristics

**Table 8: Dynamic characteristics***GND = 0 V;  $t_r = t_f = 6 \text{ ns}$ ;  $C_L = 50 \text{ pF}$ ; see [Figure 7](#).*

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b><math>T_{amb} = 25^\circ\text{C}</math></b>						
$t_{PHL}, t_{PLH}$	propagation delay nA, nB, nC, nD to nY	see <a href="#">Figure 6</a>				
		$V_{CC} = 2.0 \text{ V}$	-	33	110	ns
		$V_{CC} = 4.5 \text{ V}$	-	12	22	ns
		$V_{CC} = 6.0 \text{ V}$	-	10	19	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	10	-	ns
$t_{THL}, t_{TLH}$	output transition time	see <a href="#">Figure 6</a>				
		$V_{CC} = 2.0 \text{ V}$	-	19	75	ns
		$V_{CC} = 4.5 \text{ V}$	-	7	15	ns
		$V_{CC} = 6.0 \text{ V}$	-	6	13	ns
$C_{PD}$	power dissipation capacitance	$V_i = \text{GND to } V_{CC}$	[1]	-	15	-
<b><math>T_{amb} = -40^\circ\text{C to } +85^\circ\text{C}</math></b>						
$t_{PHL}, t_{PLH}$	propagation delay nA, nB, nC, nD to nY	see <a href="#">Figure 6</a>				
		$V_{CC} = 2.0 \text{ V}$	-	-	140	ns
		$V_{CC} = 4.5 \text{ V}$	-	-	28	ns
		$V_{CC} = 6.0 \text{ V}$	-	-	24	ns
$t_{THL}, t_{TLH}$	output transition time	see <a href="#">Figure 6</a>				
		$V_{CC} = 2.0 \text{ V}$	-	-	95	ns
		$V_{CC} = 4.5 \text{ V}$	-	-	19	ns
		$V_{CC} = 6.0 \text{ V}$	-	-	16	ns
<b><math>T_{amb} = -40^\circ\text{C to } +125^\circ\text{C}</math></b>						
$t_{PHL}, t_{PLH}$	propagation delay nA, nB, nC, nD to nY	see <a href="#">Figure 6</a>				
		$V_{CC} = 2.0 \text{ V}$	-	-	165	ns
		$V_{CC} = 4.5 \text{ V}$	-	-	33	ns
		$V_{CC} = 6.0 \text{ V}$	-	-	28	ns
$t_{THL}, t_{TLH}$	output transition time	see <a href="#">Figure 6</a>				
		$V_{CC} = 2.0 \text{ V}$	-	-	110	ns
		$V_{CC} = 4.5 \text{ V}$	-	-	22	ns
		$V_{CC} = 6.0 \text{ V}$	-	-	19	ns

[1]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu\text{W}$ ).

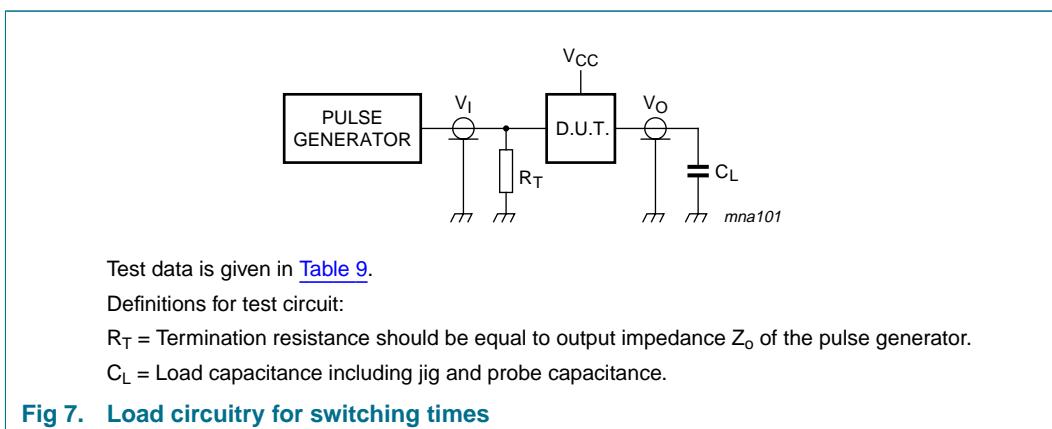
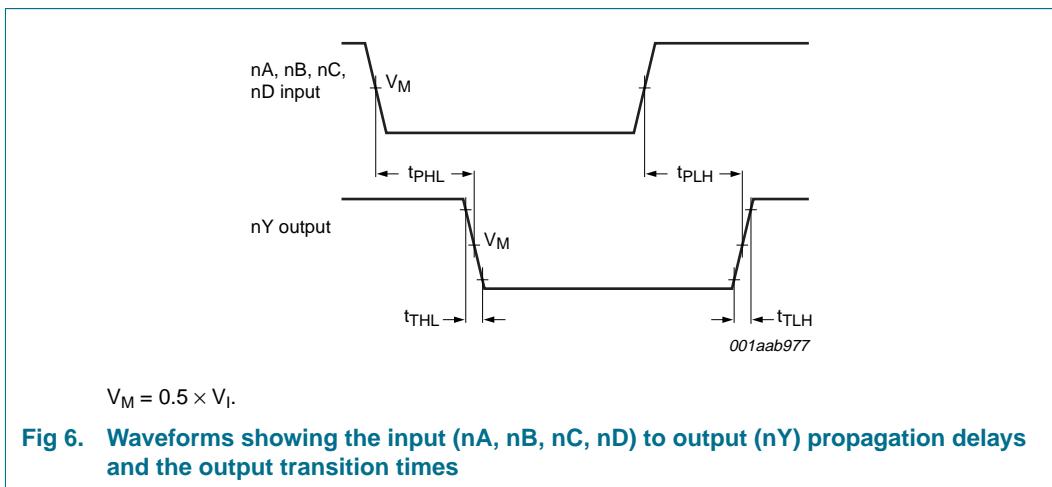
$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

 $f_i$  = input frequency in MHz; $f_o$  = output frequency in MHz; $C_L$  = output load capacitance in pF; $V_{CC}$  = supply voltage in V;

N = number of inputs switching;

$\sum(C_L \times V_{CC}^2 \times f_o)$  = sum of outputs.

## 12. Waveforms



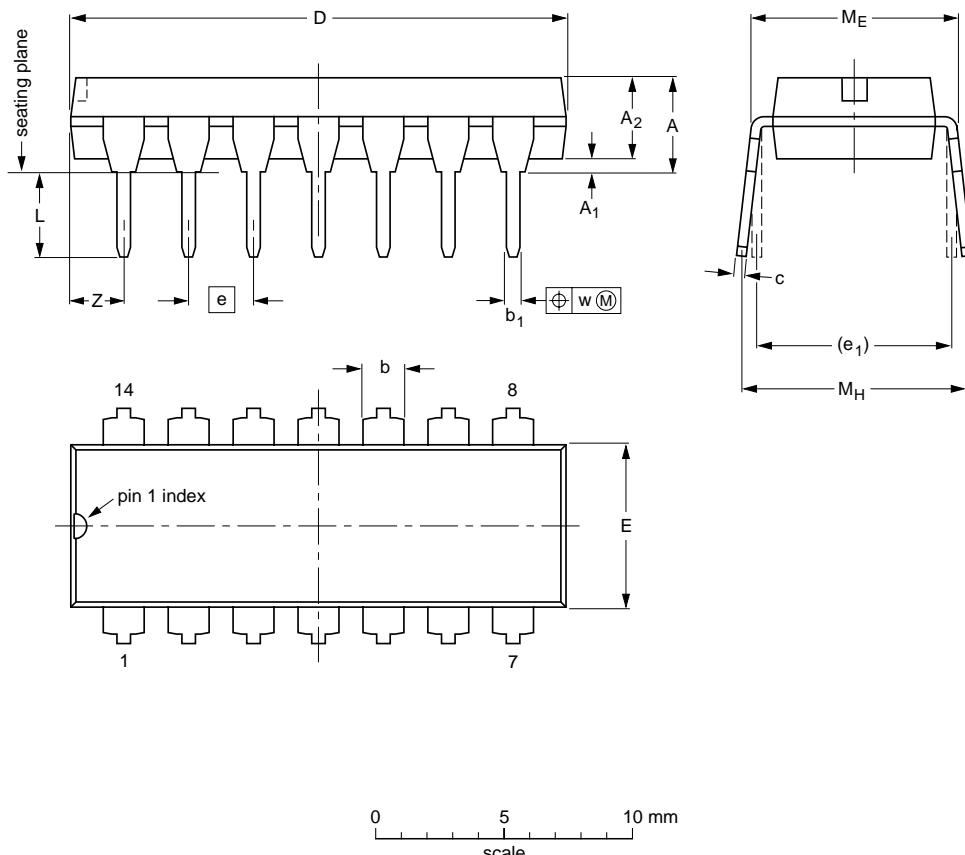
**Table 9: Test data**

Supply	Input		Load
$V_{CC}$	$V_I$	$t_r, t_f$	$C_L$
2.0 V	$V_{CC}$	6 ns	50 pF
4.5 V	$V_{CC}$	6 ns	50 pF
6.0 V	$V_{CC}$	6 ns	50 pF
5.0 V	$V_{CC}$	6 ns	15 pF

## 13. Package outline

DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1



## DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	e <sub>1</sub>	L	M <sub>E</sub>	M <sub>H</sub>	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.02	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.1	0.3	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

**Note**

1. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT27-1	050G04	MO-001	SC-501-14			99-12-27 03-02-13

**Fig 8. Package outline SOT27-1 (DIP14)**

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1

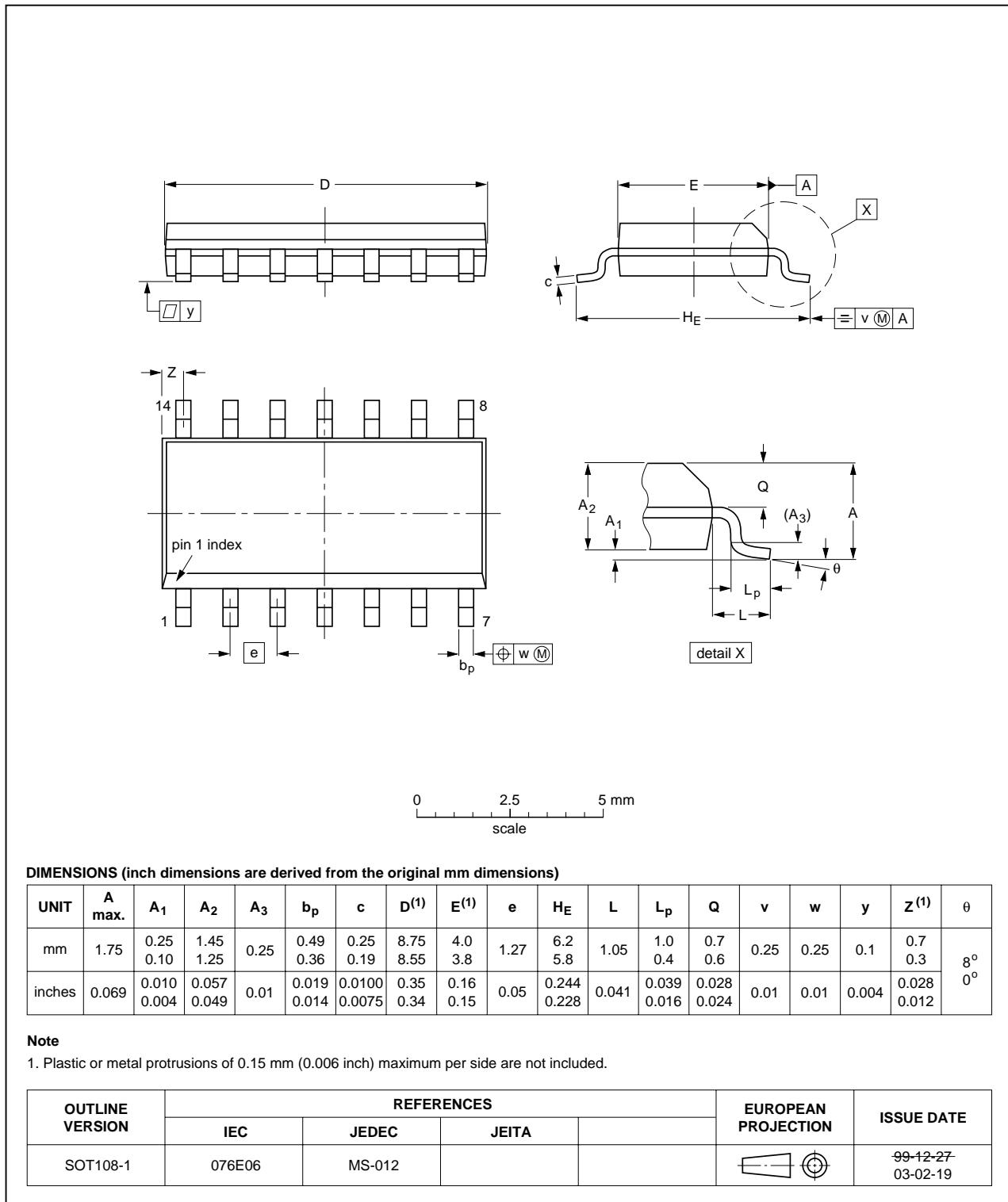


Fig 9. Package outline SOT108-1 (SO14)

SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1

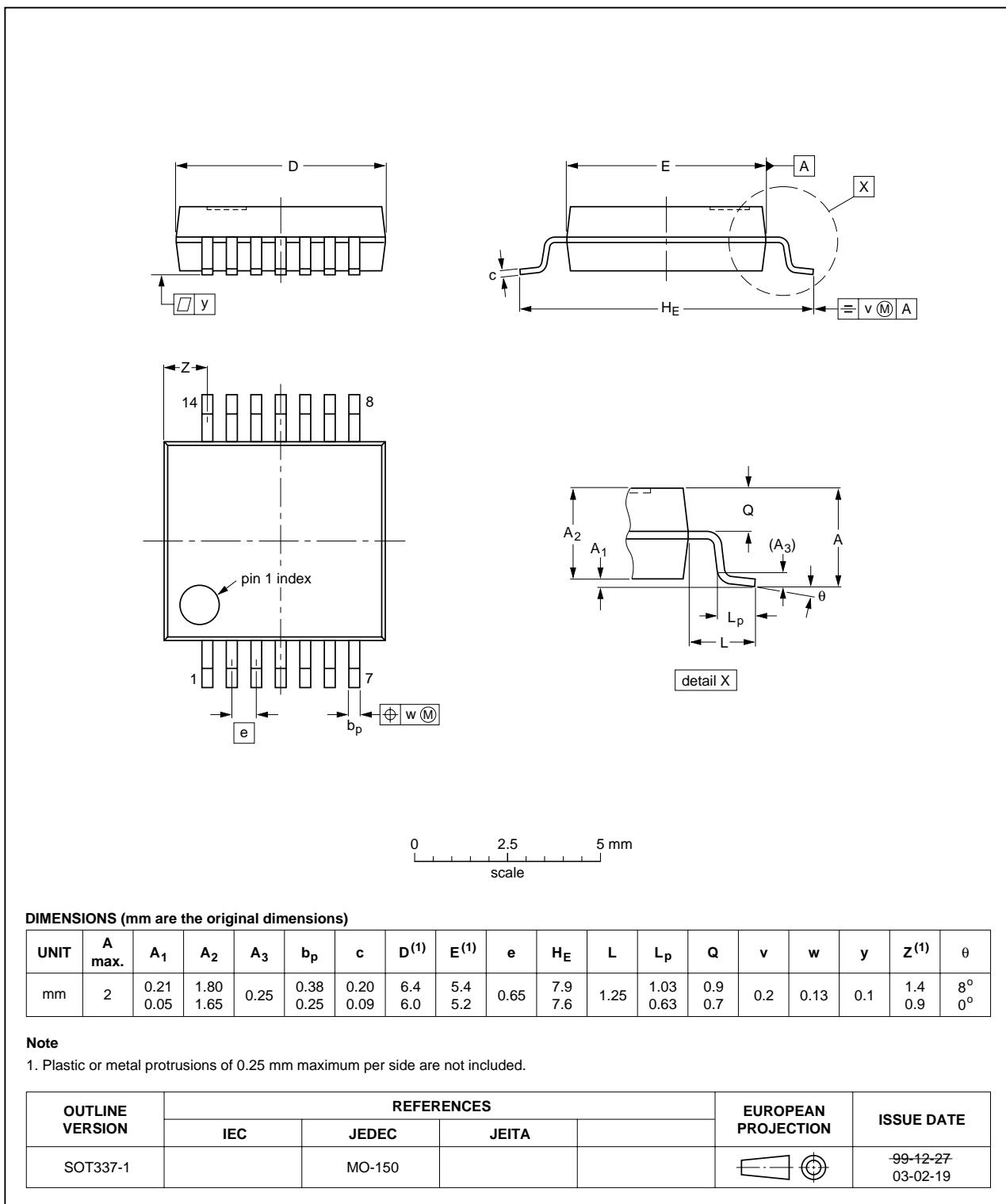


Fig 10. Package outline SOT337-1 (SSOP14)

## 14. Revision history

**Table 10: Revision history**

Document ID	Release date	Data sheet status	Change notice	Doc. number	Supersedes
74HC21_3	20041112	Product data sheet	-	9397 750 13806	74HC_HCT21_CNV_2
Modifications:	<ul style="list-style-type: none"><li>• The format of this data sheet has been redesigned to comply with the current presentation and information standard of Philips Semiconductors.</li><li>• Removed type number 74HCT21.</li><li>• Inserted family specification.</li></ul>				
74HC_HCT21_CNV_2	19970828	Product specification	-	-	74HC_HCT21_1
74HC_HCT21_1	19901201	Product specification	-	-	-

## 15. Data sheet status

Level	Data sheet status [1]	Product status [2][3]	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
III	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

[1] Please consult the most recently issued data sheet before initiating or completing a design.

[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL <http://www.semiconductors.philips.com>.

[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

## 16. Definitions

**Short-form specification** — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

**Limiting values definition** — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

**Application information** — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

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For sales office addresses, send an email to: [sales.addresses@www.semiconductors.philips.com](mailto:sales.addresses@www.semiconductors.philips.com)

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